

Harvatek 2.88mm Round LED LAMP HV-52G3224C-J0013

Official Product	HV-52G3224C-J0013	Customer Part No.		Data Sheet No.
	********	********		HV-52G3224C-J0013
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- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

Official Product	HV-52G3224C-J0013	Customer Part No.		Data Sheet No.
	********	********		HV-52G3224C-J0013
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Feb.14 2022	Version of 1.1	Page 2/12

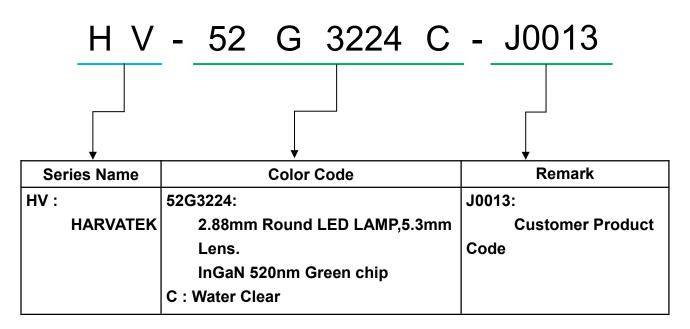


Compliance and Certification

ISO9002, QS9000 and ISO14001 Certified RoHS Compliant



Orderable Information



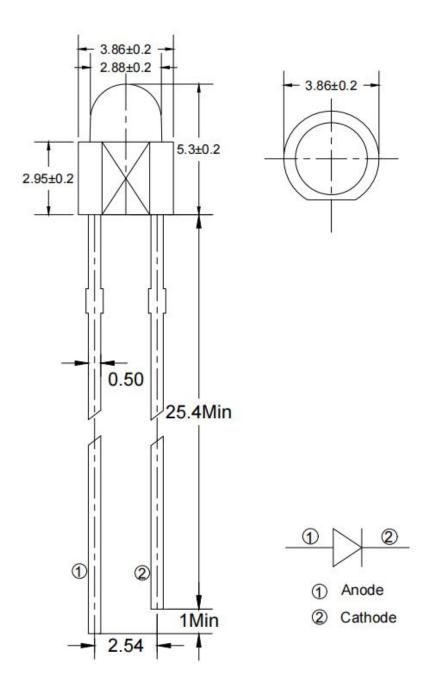
Features:

- Stable Color
- Popular 2.88mm Round package, 5.3mm lens height.
- Water Clear lens

Official Product	HV-52G3224C-J0013	Customer Part No.		Data Sheet No.
	*******	********		HV-52G3224C-J0013
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Package Dimensions:



Notes:

- 1.All dimensions are millimeters.
- 2.Tolerance is +/-0.25mm unless otherwise noted.
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Official Product	HV-52G3224C-J0013	Customer Part No.		Data Sheet No.
	********	********		HV-52G3224C-J0013
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Feb.14 2022	Version of 1.1	Page 4/12



Absolute Maximum Ratings at Ta=25℃

Parameter	Symbol	Rating	Unit
Forward Current	lF	30	mA
Operating Temperature	T_{opr}	-40to+85	$^{\circ}$
Storage Temperature	T_{stg}	-40to+85	$^{\circ}$
Soldering Temperature*1	T_{sol}	260±5	$^{\circ}$
Power Dissipation	P _d	100	mW
Reverse Voltage	V _R	5	V
Peak Forward Current*2	I _{FP}	100	mA
ESD Human mode	VESD	2000	V

^{*1:}Soldering time \leq 5 seconds.

Official Product	HV-52G3224C-J0013	Customer Part No.		Data Sheet No.
	********	*********		HV-52G3224C-J0013
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Feb.14 2022	Version of 1.1	Page 5/12

^{*2:}Pulse Width≦ 100µs and Duty≦ 1%.



Electrical and Optical Characteristic

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	V _F	I⊧=20 mA	/	3.0	3.4	V
Reverse Current	I _R	V _R = 5 V	/	/	10	μΑ
Luminous Intensity	I _V	I _F =20 mA	3900	8000	/	mcd
Viewing Angle	201/2	I _F =20 mA	/	35	/	deg
Dominant Wavelength	λd	I⊧=20 mA	/	520	/	nm
Peak Wavelength	λρ	I _F =20 mA	/	516	/	nm
Spectrum Radiation Bandwidth	Δλ	I⊧=20 mA	/	20	/	nm

Notes:

 θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

Official Product	HV-52G3224C-J0013	Customer Part No.		Data Sheet No.
	*******	********		HV-52G3224C-J0013
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Feb.14 2022	Version of 1.1	Page 6/12



Specifications for Bin Grading:

lv (mcd)				
Grade	Min.	Max.		
Z	3900	8500		
Z1	6700	12000		
Z2	10000	18000		

	λd (nm)				
Grade	Min.	Max.			
0	514.5	517.5			
1	516.5	519.5			
2	518.5	521.5			
3	520.5	523.5			
4	522.5	525.5			
5	524.5	527.5			

Notes:

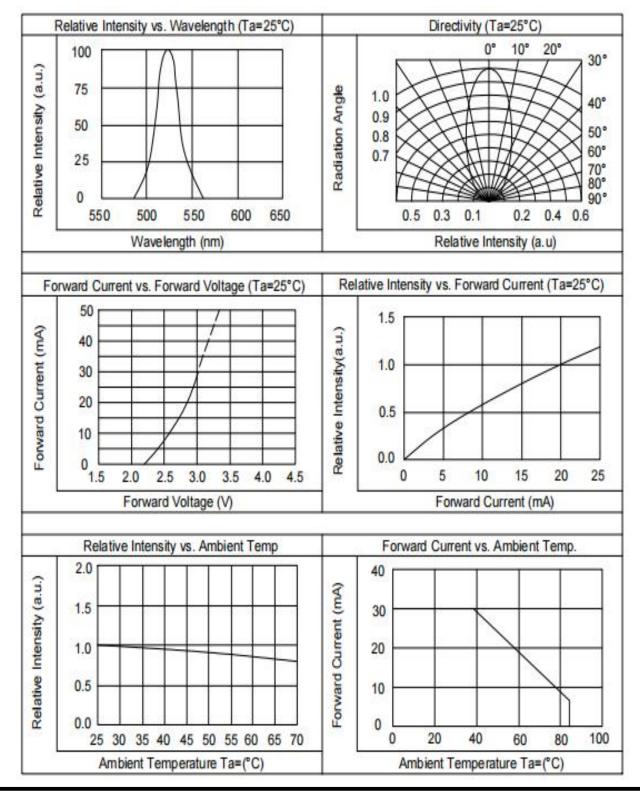
1.Luminous intensity:+/-15%.

2.Wavelength: +/-1nm.

Official Product	HV-52G3224C-J0013	Customer Part No.		Data Sheet No.
	*******	********		HV-52G3224C-J0013
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Typical Electro-Optical Characteristics Curve



Official Product	HV-52G3224C-J0013	Customer Part No.		Data Sheet No.
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Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Feb.14 2022	Version of 1.1	Page 8/12

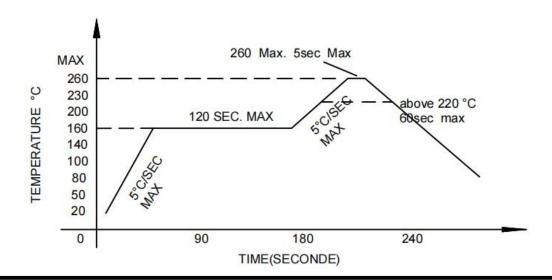


Soldering condition

- 1. Careful attention should be paid during soldering. When soldering, leave more then 2mm from solder joint to Led, and soldering beyond the base of the tie bar is recommended.
- 2. Avoiding applying any stress to the lead frame while the LED are at high temperature particularly when soldering.
- 3. Dip and hand soldering should not be done more than one time.
- 4. After soldering the LED, the epoxy bulb should be protected from mechanical shock or vibration until the LED return to room temperature.
- 5. A rapid-rate process is not recommended for cooling the LED down from the peak temperature.
- 6. Although the recommended soldering conditions are specified in the above table, dip or hand soldering at the lowest possible temperature is desirable for the LED.
- 7. Wave soldering parameter must be set and maintain according to recommended temperature and dwell time in the solder wave.

Recommended soldering conditions

Hand Soldering		Wave Soldering		
Temp. at tip of iron	Temp. at tip of iron 300℃ Max. (30W Max.)		160℃ Max. (120 sec Max.)	
Soldering time 3 sec Max. Bath		Bath temp. & time	260 Max., 5 sec Max	
Diotopoo	2mm Min.(From solder joint to	Distance	2mm Min. (From solder joint	
Distance	Led)	Distance	to Led)	



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	*******	*********		HV-52G3224C-J0013
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Feb.14 2022	Version of 1.1	Page 9/12



Reliability test items and conditions:

The reliability of products shall be satisfied with items listed below.

Confidence level: 97%

LTPD:3%

No	Item	Test Conditions	Test Hours/Cycle	Sample Size	Failure Judgment Criteria	Ac/Er
1	Solder Heat	TEMP:260℃±5℃	10 SEC	76 PCS		0/1
2	Temperature Cycle	H:+100 °C 15min ∫ 5min L:-40 °C 15min	300 CYCLES	76 PCS		0/1
3	Thermal Shock	H:+100°C 5min ∫ 10sec L:-10°C 5min	300 CYCLES	76 PCS	lv≦lvt*0.5 or	0/1
4	High Temperature Storage	TEMP:100℃	1000 HRS	76 PCS	Vf≧U or	0/1
5	Low Temperature Storage	TEMP:-40℃	1000 HRS	76 PCS	Vf≦L	0/1
6	DC Operating Life	TEMP:25℃ IF=20mA	1000 HRS	76 PCS		0/1
7	High Temperature / High Humidity	85℃/85%RH	1000 HRS	76 PCS		0/1

Note: Ivt: To test Iv value of the chip before the reliability test.

Iv: The test value of the chip that has completed the reliability test

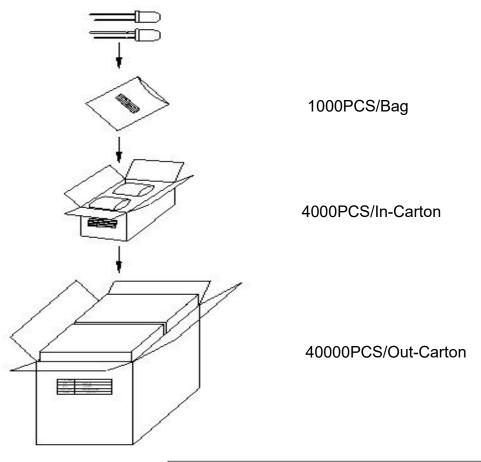
U: Upper Specification Limit

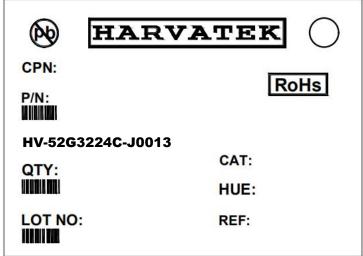
L: Lower Specification Limit

Official Product	HV-52G3224C-J0013	Customer Part No.		Data Sheet No.	
	*******	*****		HV-52G3224C-J0013	
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Feb.14 2022	Version of 1.1	Page 10/12	



Packing Specification:





Official Product	HV-52G3224C-J0013	Customer Part No.		Data Sheet No.
	********	******		HV-52G3224C-J0013
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Feb.14 2022	Version of 1.1	Page 11/12



Revision History

Revision	Page	Version No.	Revision Date
Initial Release		1.0	09-06-2021
Increase the ESD conditions and modify the brightness level	5/7	1.1	02-14-2022

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Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Feb.14 2022	Version of 1.1	Page 12/12